

Heat Sink



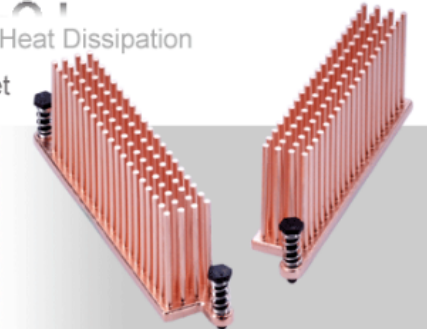
Specification

- 1. Material: CU 1100
- 2. Dimension:
  - Foot print: 87\*16 mm
  - Height: 29.6 mm
  - Base(thickness): 2.6 mm
- 3. Finish: Redox

MST-81

Exceptional Heat Dissipation

For Mosfet



Performance

Heat Source (L*W)	65*11
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